#### IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of

Ryu SHIMIZU

Serial No.: 10/669,058

Filed: September 24, 2003

Customer Number: 20277

Confirmation Number:

Group Art Unit:

Examiner:

For: METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE INCLUDING A MULTI-LAYER INTERCONNECT STRUCTURE

#### REQUEST FOR OFFICIAL FILING RECEIPT

Mail Stop OFR Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Sir:

The above-referenced patent application was filed in the U.S. Patent and Trademark Office on September 24, 2003, as evidenced by the attached copies of the return receipt postcard and transmittal letter. To date, the undersigned has not received the Official Filing Receipt regarding this application.

It is respectfully requested that the undersigned be furnished with an Official Filing Receipt as soon as possible.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

Stephen A. Becker

Registration No. 26,527

600 13<sup>th</sup> Street, N.W. Washington, DC 20005-3096 (202) 756-8000 SAB:gav Facsimile: (202) 756-8087

Date: March 24, 2004

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**Customer Number: 20277** 

### UTILITY PATENT APPLICATION UNDER 37 CFR 1.53(b)

Mail Stop Patent Application Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450 Sir:

Transmitted herewith for filing is the patent application of:

INVENTOR: Ryu SHIMIZU

FOR: METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE

INCLUDING A MULTI-LAYER INTERCONNECT STRUCTURE

Enclos	sed are:
$\boxtimes$	28 pages of specification, claims, abstract.
$\boxtimes$	Declaration and Power of Attorney.
$\boxtimes$	Priority Claimed.
	Certified copy of Japanese Patent Application No. 2002-287671
$\boxtimes$	11 sheets of formal drawing.
$\boxtimes$	An assignment of the invention to SANYO ELECTRIC CO., LTD.
	and the assignment recordation fee.
	An associate power of attorney.
	A verified statement to establish small entity status under 37 CFR 1.9 and 37 CFR 1.27.
	Information Disclosure Statement, Form PTO-1449 and reference.
$\overline{\boxtimes}$	Return Receipt Postcard

The filing fee has been calculated as shown below:

	NO. OF CLAIMS		EXTRA CLAIMS	RATE	AMOUNT	
Total Claims	9	-20	0	\$18.00	\$0.00	
Independent Claims	3	-3	0	\$84.00	\$0.00	
	\$0.00					
	\$750.00					
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	\$0.00					
			Assignment &	Recording Fee	\$40.00	
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Please charge my Deposit Account No. 500417 in the amount of \$790.00. A duplicate copy of this sheet is enclosed.

The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 500417. A duplicate copy is enclosed.

Any additional filing fees required under 37 CFR 1.16.

The Commissioner is hereby authorized to charge payment of the following fees during the pendency of this application or credit any overpayment to Deposit Account No. 500417. A duplicate copy of this sheet is enclosed.

Any patent application processing fees under 37 CFR 1.17.

Any filing fees under 37 CFR 1.16 for presentation of extra claims.

Respectfully submitted,

MCDERMOTT, WILL & EMERY

Arthur J. Steiner

Registration No. 26,106

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Date: September 24, 2003

Applicant Ryu SHIMIZU		Docket No.	65933-0	45						
METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE INCLUDING A MULTI-LAYER Title: INTERCONNECT STRUCTURE  Serial/Reg /P atent No.  NOT YET ASSIGNED										
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☐ Information Disclosure Statement			Req. fo	or Certificate o	of Correction					
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CMS Descrip.: 1-750.00 4-40.00 EARLY SERIAL NUMBER										

THE PATENT AND TRADEMARK OFFICE DATE STAMPED HEREON IS ACKNOWLEDGEMENT THAT THE ITEMS, CHECKED ABOVE, WERE RECEIVED BY THE PTO ON THE DATE STAMPED.